



June 22, 2005

TO: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572
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SUBJECT: Serial #: 10/614,928
File Date: July 8, 2003
Inventor: Jin-Yuan Lee
Examiner: Menz, Douglas M.
Art Unit: 2891
Title: Structure of High Performance Combo Chip and Processing
Method
Customer Number: 28112

PRELIMINARY AMENDMENT

Please enter the attached Preliminary Amendment.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 23, 2005

Signature SB
Stephen B. Ackerman, Reg. No. 37,761

Date: 6/23/05

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.